



SDA006

DATA BUS TRANSIENT SUPPRESSOR / 3-PHASE FULL WAVE BRIDGE RECTIFIER

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For 3-Phase Full Wave Bridge Rectification, or 3 Dataline Rail Clamp
- Lead Free By Design/RoHS Compliant (Note 3)
- "Green" Device (Note 4)

IEC Compatibility (Note 5)

- 61000-4-2 (ESD) Air-10kV Contact-8kV
- 61000-4-5 (Surge) 8x20μs, 14.5 Amperes

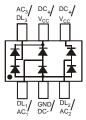
SOT-363



TOP VIEW

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 4)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



TOP VIEW Internal Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current (Note 1)	I _{FM}	215	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I _{FSM}	2.0 1.0 0.5	А
Clamping Voltage (Note 6) @ Ipp = 14.5A 8x20μs Waveform	Vc	16	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	200	mW
Power Dissipation (Note 2)	P _D	300	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{\theta JA}$	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Notes:

- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

 2. Device mounted on Alumina PCB, 0.4 inch x 0.3 inch x 0.024 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead.
- No purposedary added read.
 Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Tested with V_{CC} connected to Ground to simulate appropriate V_{CC} decoupling to Ground.
- 6. Reference to V_{CC} or Ground.

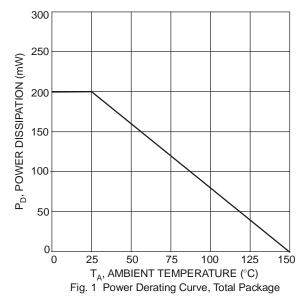
Downloaded from Elcodis.com electronic components distributor

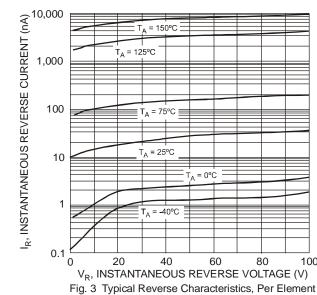


Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75	_		V	$I_R = 2.5 \mu A$
Forward Voltage (Note 7)	V_{F}		_	0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 7)	I _R		_	2.5 50 30 25	μА	$V_R = 75V$ $V_R = 75V$, $T_J = 150^{\circ}C$ $V_R = 25V$, $T_J = 150^{\circ}C$ $V_R = 20V$
Junction Capacitance (per element)	CJ	_	_	2.0	pF	$V_R = 0V$, $f = 1.0MHz$
Capacitance, Between I/O Lines (I/O1 & I/O2)	C_LL	_	35	_	рF	$V_R = 0V$, $f = 1.0MHz$
Capacitance, Between I/O Line and Ground	C_LG	_	11	_	рF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}		_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Notes: 7. Short duration pulse test used to minimize self-heating effect.





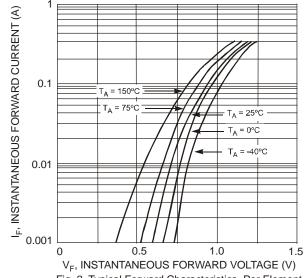


Fig. 2 Typical Forward Characteristics, Per Element

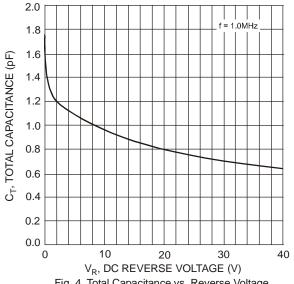


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

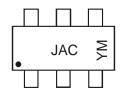


Ordering Information (Note 8)

Part Number	Case	Packaging
SDA006-7	SOT-363	3000/Tape & Reel

Notes: 8. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



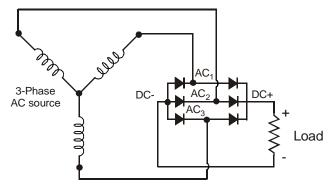
JAC = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

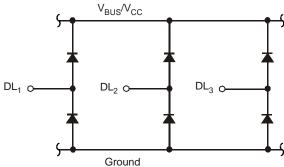
Year	2002	2003	2004	2005	200	6 20	007	2008	2009		2010	2011	2012
Code	N	Р	R	S	Т		U	V	W		Χ	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	g S	ер	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	,	9	0	N	D

Typical Applications

Three Phase, Full-Wave Bridge Rectifier

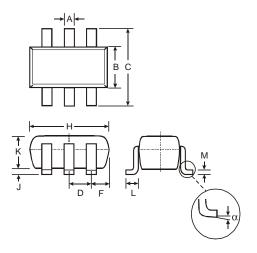


Data Line Bus Transient Suppressor



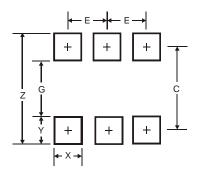


Package Outline Dimensions



SOT-363						
Dim	Min	Max				
Α	0.10	0.30				
В	1.15	1.35				
С	2.00 2.20					
D	0.65 Nominal					
F	0.30	0.40				
Н	1.80	2.20				
J	_	0.10				
K	0.90	1.00				
L	0.25	0.40				
M	0.10	0.25				
α	0°	8°				
All Di	All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Υ	0.6
С	1.9
F	0.65

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